

**IN THE UNITED STATES PATENT & TRADEMARK OFFICE****EXPEDITED HANDLING**  
**Response under 37 C.F.R. 1.116**

Appln. Ser. No.:	Filed:	Inventor(s):	Atty Dkt:
09/825,418	3 April 2000	Y. Awakura	114GI-135 (0694-135)
Title: Wiring Board Comprising Granular Magnetic Film			
Examiner: T.T. Dinh			Art Unit: 2827

Asst. Comm'r for Patents  
Washington, D.C. 20231-000113 Pages Total **VIA FACSIMILE**  
703-305-1341**SUPPLEMENTAL RESPONSE AND AMENDMENT UNDER 37 C.F.R. § 1.116**

Dear Sir:

In complete and timely response to the Office action mailed 16 January 2003, in which the rejections of the claims were designated as final, please first amend the subject application as follows, the amendments being shown in marked-up form in the appendix following this response.

**IN THE CLAIMS:**

Cancel claims 3, 8, 20, 21, 24, 25, and 29.

1. (Twice amended.) A wiring board comprising:  
an insulate base material;  
a conductor pattern formed thereon; and  
a magnetic thin film formed on said conductor pattern, said magnetic thin film being made of a magnetic loss material having a maximum value of  $\mu''_{\max}$  of